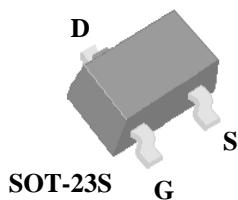
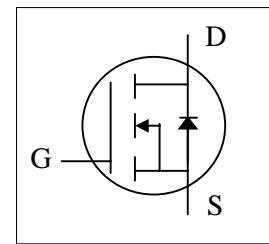




- ▼ Capable of 1.8V Gate Drive
- ▼ Small Package Outline
- ▼ Surface Mount Package
- ▼ RoHS Compliant & Halogen-Free



BV_{DSS}	20V
$R_{DS(ON)}$	90mΩ
I_D	2.5A



Description

Advanced Power MOSFETs utilized advanced processing techniques to achieve the lowest possible on-resistance, extremely efficient and cost-effectiveness device.

The SOT-23S package is widely preferred for commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

Absolute Maximum Ratings@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 8	V
$I_D @ T_A = 25^\circ\text{C}$	Drain Current ³ , $V_{GS} @ 4.5\text{V}$	2.5	A
$I_D @ T_A = 70^\circ\text{C}$	Drain Current ³ , $V_{GS} @ 4.5\text{V}$	2.0	A
I_{DM}	Pulsed Drain Current ¹	10	A
$P_D @ T_A = 25^\circ\text{C}$	Total Power Dissipation	0.833	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
R_{thj-a}	Maximum Thermal Resistance, Junction-ambient ³	150	°C/W



Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	20	-	-	V
$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance ²	$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=1.6\text{A}$	-	-	90	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=2.5\text{V}, \text{I}_D=1\text{A}$	-	-	120	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=1.8\text{V}, \text{I}_D=0.3\text{A}$	-	-	150	$\text{m}\Omega$
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=1\text{mA}$	0.25	-	1	V
g_{fs}	Forward Transconductance	$\text{V}_{\text{DS}}=5\text{V}, \text{I}_D=2\text{A}$	-	2	-	S
I_{DSS}	Drain-Source Leakage Current	$\text{V}_{\text{DS}}=20\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1	uA
I_{GSS}	Gate-Source Leakage	$\text{V}_{\text{GS}}=\pm 8\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	± 100	nA
Q_{g}	Total Gate Charge	$\text{I}_D=2.2\text{A}$	-	7	11	nC
Q_{gs}	Gate-Source Charge		-	0.7	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge		-	2.5	-	nC
$t_{\text{d(on)}}$	Turn-on Delay Time	$\text{V}_{\text{DS}}=10\text{V}$	-	6	-	ns
t_r	Rise Time		-	12	-	ns
$t_{\text{d(off)}}$	Turn-off Delay Time		-	16	-	ns
t_f	Fall Time		-	4	-	ns
C_{iss}	Input Capacitance	$\text{V}_{\text{GS}}=0\text{V}$	-	350	560	pF
C_{oss}	Output Capacitance		-	55	-	pF
C_{rss}	Reverse Transfer Capacitance		-	48	-	pF
R_{g}	Gate Resistance	f=1.0MHz	-	3.2	4.8	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$\text{I}_S=0.7\text{A}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1.2	V
t_{rr}	Reverse Recovery Time	$\text{I}_S=2\text{A}, \text{V}_{\text{GS}}=0\text{V},$	-	20	-	ns
Q_{rr}	Reverse Recovery Charge	$d\text{I}/dt=100\text{A}/\mu\text{s}$	-	13	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in² copper pad of FR4 board , t \leq 10sec ; 360 °C/W when mounted on Min. copper pad.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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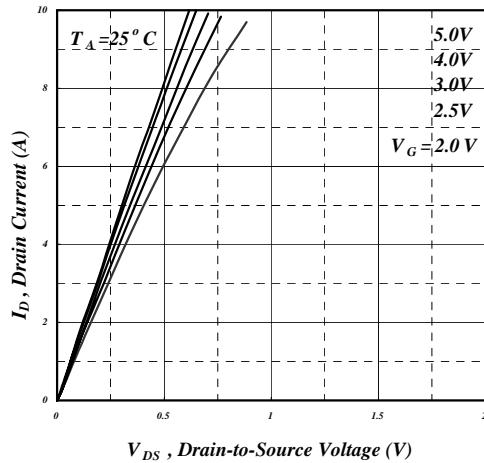


Fig 1. Typical Output Characteristics

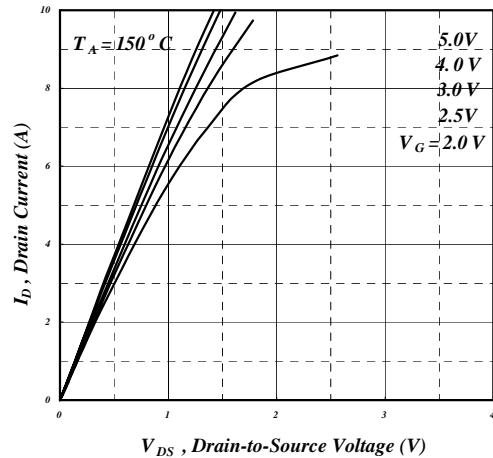


Fig 2. Typical Output Characteristics

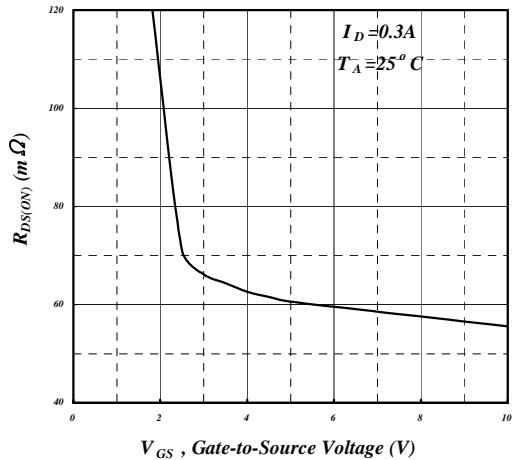


Fig 3. On-Resistance v.s. Gate Voltage

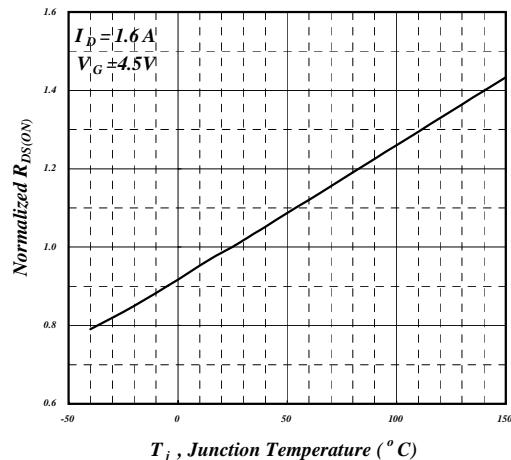


Fig 4. Normalized On-Resistance v.s. Junction Temperature

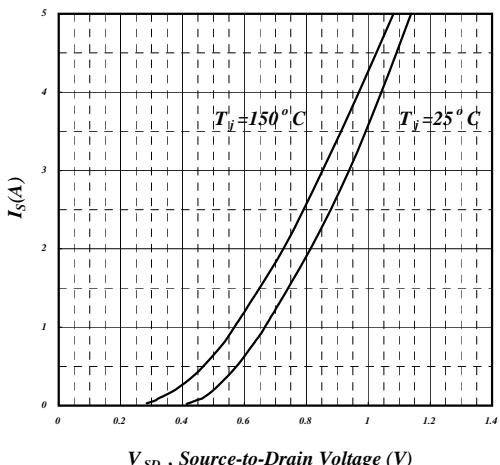


Fig 5. Forward Characteristic of Reverse Diode

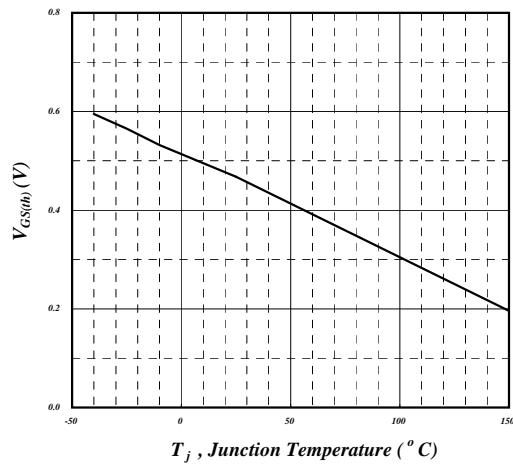
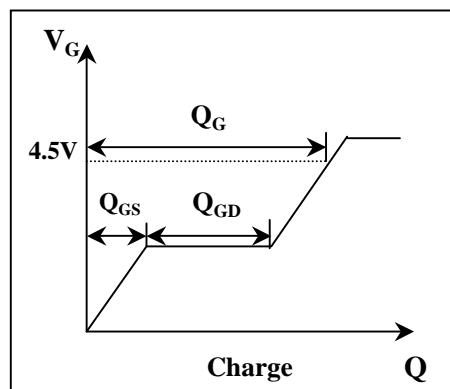
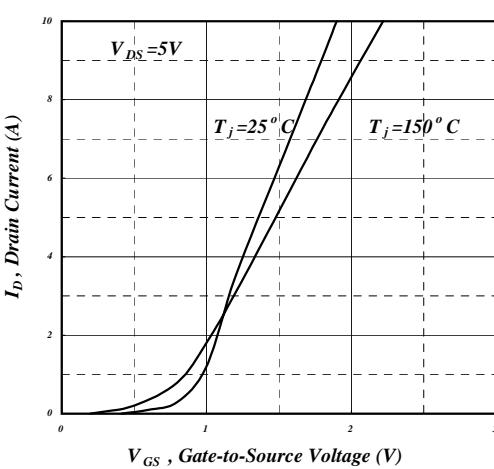
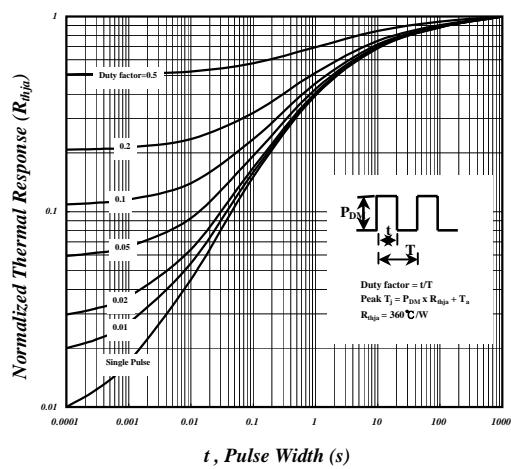
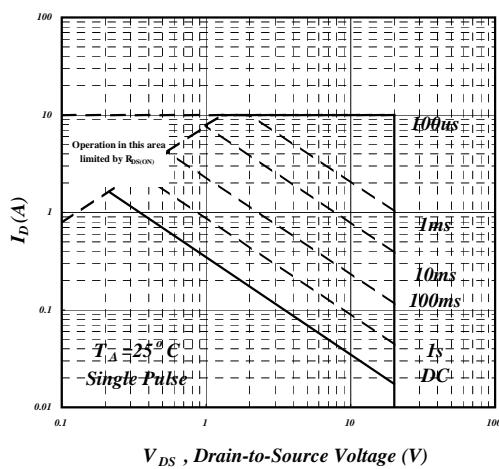
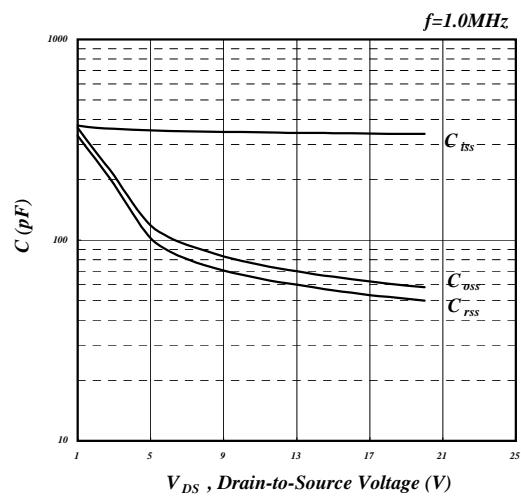
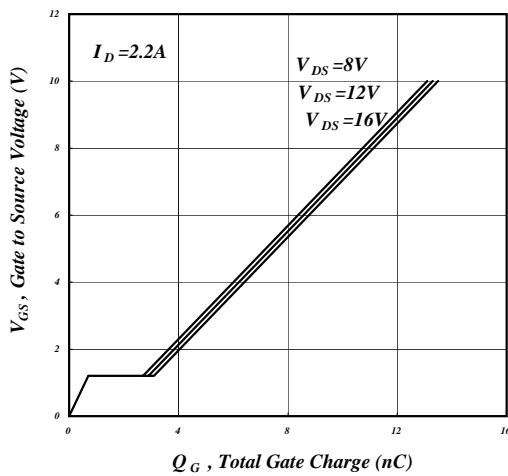


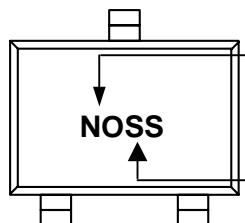
Fig 6. Gate Threshold Voltage v.s. Junction Temperature





AP2322GN

MARKING INFORMATION



Part Number : NO

Date Code : SS

SS:2004,2008,2012...

SS:2003,2007,2011...

SS:2002,2006,2010...

SS:2001,2005,2009...